

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No.: 10/647,297      Group Art Unit: 1794  
Filing Date: August 26, 2003      Examiner: Hai Vo  
Applicants: Hyun HUH et al.  
Title: POLISHING PAD CONTAINING EMBEDDED LIQUID  
MICROELEMENTS AND METHOD OF  
MANUFACTURING THE SAME  
Attorney Docket: 47881-000003/US

Customer Service Window  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314  
**Mail Stop AF**

June 30, 2008  
DO NOT ENTER: /HV/  
07/09/2008

**SUPPLEMENTAL AMENDMENT UNDER 37 C.F.R. § 1.116**

Sir:

In response to the Advisory Action mailed June 4, 2008, and the Final Office Action mailed January 18, 2008, the due date having been extended three (3) months to July 18, 2008, the following remarks are respectfully submitted in connection with the above-identified application.

**Amendments to the Claims** begins on page 2 of this Amendment.

**Remarks** begin on page 5 of this Amendment.

	Claims remaining after Amendment		Highest number previously paid for		Present extra
<b>Total</b>	14	-	31	=	0
<b>Independent</b>	1	-	3	=	0